EPISTAR

> Mechanical Specification:

- (1) Dimension
 - Chip size: 20 mil x 20 mil (500±25 μm x 500±25 μm)
 - Thickness: 8.8 mil (225±25 $\mu m)$
 - N bonding pad: 4.5 mil (115±10 $\mu m)$

(2) Metallization

- Topside N electrode: Au alloy
- Backside P electrode: Au alloy

Features:

- \cdot High luminous intensity
- \cdot Thin film structure
- · Vertical electrode
- \cdot High driving current

Applications:

- Traffic signal
- \cdot Lighting



N-electrode

Si-substrate

P-electrode

> Electro-optical Characteristics at 25°C:

Parameter	Symbol		Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf1		lf = 10μΑ	1.3	-	-	V
	Vf2		lf = 150mA	-	2.3	2.8	V
Reverse Current	lr		Vr = 10V	-	-	5.0	μΑ
Peak Wavelength	λр		lf = 150mA	-	631	-	nm
Dominant Wavelength ⁽¹⁾	λd		lf = 150mA	619	624	629	nm
Spectra Half-width	Δλ		lf = 150mA	-	20	-	nm
Luminous Intensity ⁽²⁾⁽³⁾	lv	H10	lf = 150mA	5300	-	-	mcd
		H11		6300	-	-	
		H12		7500	-	-	

Note:

(1) Basically, the wavelength span is 10nm; however, customers' special requirements are also welcome.

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(3) Luminous intensity is measured by EPISTAR's equipment on bare chips.

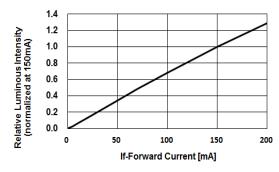
Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25°C	≤ 200	mA
Reverse Voltage	Vr	Ta = 25°C	≤ 10	V
Junction Temperature	Тј	-	≤ 115	°C
Storage Temperature	Tstg	Chip	-40 ~ +85	°C
		Chip-on-tape/storage	5 ~ 35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	- 280(<10sec)		°C

> Absolute Maximum Ratings:

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board (MCPCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.

> Characteristic Curves:







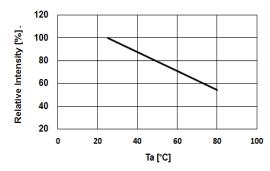


Fig.5 – Dominant Wavelength (@150mA) vs. Ambient Temperature

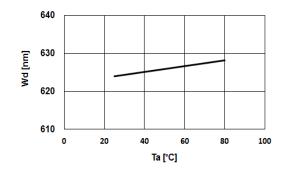


Fig.2 – Forward Current vs. Forward Voltage

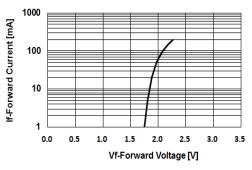


Fig.4 – Forward Voltage (@150mA) vs. Ambient Temperature

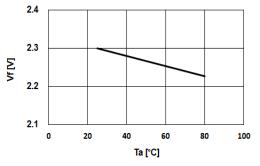


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 115°C)

